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FABRICATION AND CHARACTERIZATION OF LIQUID AND GASEOUS MICRO-AND NANOJETS

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ABSTRACT

This paper reports on the fabrication and characterization of liquid and gaseous jets ejected from microfabricated nozzles with dimensions ranging from 500 nm to 12 μm. Unlike previous work reporting the fabrication of nano-orifices defined within the thickness of the substrates [1-4], the in-plane nanonozzles presented in this paper are designed to sustain the high pressures necessary to obtain substantial nanofluidic jet flows. This approach also allows important three-dimensional features of nozzle, channel and fluidic reservoir to be defined by design and not by fabrication constraints, thereby meeting important fluid-mechanical criteria such as a fully-developed flow. The shrinking jet dimensions demand new metrology tools to investigate their flow behavior. A laser shadowgraphy technique is used to visualize and image the jet flows. Micromachined heated and piezoresistive cantilevers are used to investigate the thrust and heat flux characteristics of the jets.

KEYWORDS

Micro/Nanonozzle, Micro/Nanojet, KOH wet etching, Laser shadowgraphy, Cantilever

INTRODUCTION

With advancements in microfluidics, applications of micro/nanojets are expanding to a variety of areas, including ink jet printing [4], drug [5] and gene delivery, localized

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etching/nanofabrication [3], selective deposition [6] and microelectronic cooling [7]. In the past very little work has been done on sub 10 µm liquid jets.

Previously work has been reported on fabrication of out-of-plane silicon micro/nanonozzles utilizing Focused Ion Beam (FIB) milling of potassium hydroxide (KOH) etched hollow pyramids [1-3]. Materials other that silicon have been employed in some cases like generation of organic molecular nanojets by commercial glass pipettes of submicron orifice diameter [6,8] and polymeric nanonozzles fabricated by sacrificial template printing [9]. The above mentioned methods are not suitable for high pressure applications, or involve serial fabrication processes that may make mass-manufacturing more difficult.

The in-plane fabrication approach presented in this work is designed to produce silicon nozzles capable of supporting large pressure drops required to drive micro/nanojets. Silicon is chosen as the material for this on account of its good mechanical properties and availability of many silicon based microfabrication technologies. The entire nozzle unit is fabricated by a single mask step using anisotropic wet etching. All the dimensions and profiles are defined by the design giving maximum flexibility to meet design requirements. The aspect ratio of the cross section of nozzle channels is maintained very close to unity to ensure generation of stable circular jets. Apart from the simplicity of fabrication and flexibility of design, this approach offers a further advantage of ability to reduce the micromachined orifice dimensions to the submicron range very easily by controlled oxidative sealing.

Current trends in microfluidic miniaturization have led to an interest in examining the behavior of liquids at the nanoscale. In the absence of experiments that could directly measure liquid flow at this scale, numerous studies have been focused on molecular dynamics simulations [10,11]. In this work, free liquid microjet flows are visualized and imaged by laser shadowgraphy. Piezoresistive and thermal cantilevers are used to characterize liquid and gaseous jets.

MICRO/NANONOZZLE FABRICATION

The micro/nanojets are generated from micromachined silicon nozzles consisting of a nozzle channel and a small scale pressurized reservoir. Figure 1 depicts the fabrication sequence of the nozzles. Silicon dioxide is grown (Fig. 1a) on a double-side polished 450 µm thick (100) silicon wafer. Standard photolithography is performed to delineate the nozzle structure (Fig. 1b). Anisotropic KOH etching (concentration of KOH = 40% at 70˚C) is carried out to define channels and reservoirs into the silicon substrate (Fig. 1c). After stripping the oxide layers, the wafer topside is fusion bonded with another silicon wafer, and the stack is annealed at 1100 ºC for 4 hours, forming enclosed nozzles (Fig. 1d). The nozzles are then individualized using a through-wafer Inductively Coupled Plasma (ICP) etch or alternatively by dicing (Fig. 1e). The top surface of the nozzles containing the orifice outlet is polished using chemical mechanical polishing. This removes any fabrication imperfection on the exit plane. Oxidative sealing is then optionally utilized to reduce the openings of the nozzles from a few microns to the nanometer range (Fig. 1f). Figure 2 shows a schematic of an individualized nozzle with enclosed channel and reservoir.

This fabrication technology presents several interesting

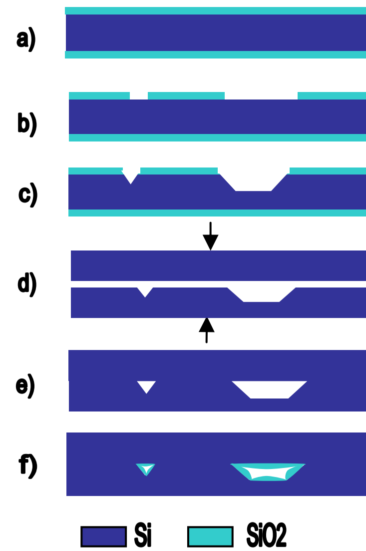

Fig. 1: Fabrication sequence

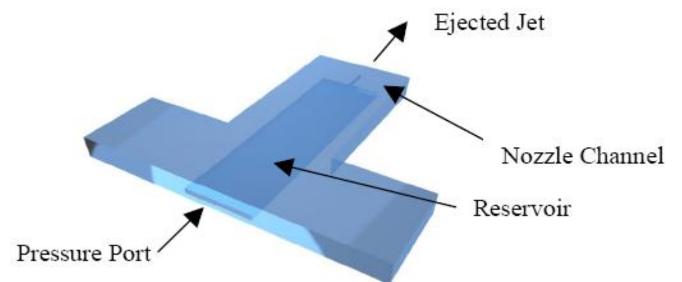

Fig. 2: 3-D schematic of an individualized nozzle with fluid reservoir and nozzle channel

features. The entire nozzle structure, from the reservoir to the exit orifice is defined by photolithography, providing high design flexibility. Parameters such as channel length and width, and reservoir width and depth are easily alterable by design (Fig. 3). The cross section area of the reservoir is chosen in order to minimize the surface area of the interior of the reservoir while obtaining a maximum possible entry (cross section) surface area for the fluid. This optimization helps in increasing the pressure withstanding capacity of the nozzle. The channel length is chosen to be 10 times the channel width in order to ensure generation of a fully developed flow.

In the above approach, a single anisotropic KOH wet etching step allows the definition of triangular channels with very small cross-sections while etching a deeper reservoir. KOH etching exhibits interesting properties as it etches different silicon crystal planes with different etch rates: e.g., the (100) plane is etched 70 times faster than the (111) plane (concentration of KOH = 34% at 70.9˚C) [12]. This property allows the fabrication of structures of different depths using a single mask process (Fig. 4). Since the line width of the channel is very small compared to the reservoir, the early intersection of (111) planes results in etch stop. We obtain a triangular channel

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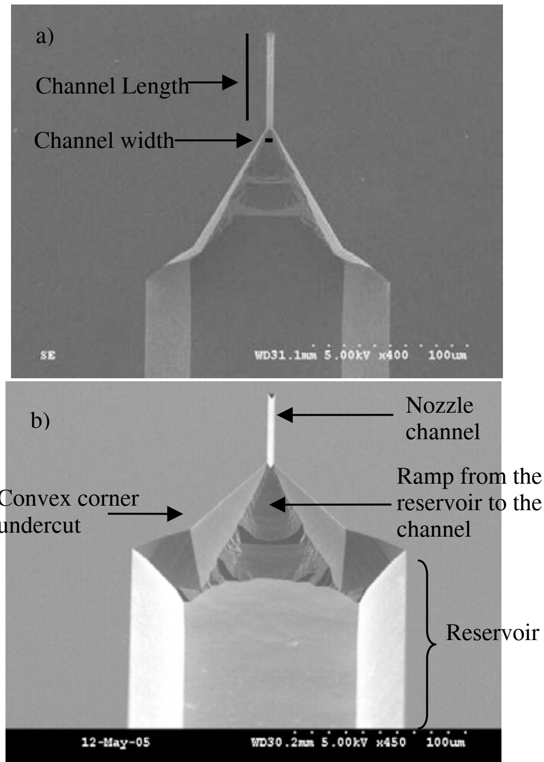

Fig. 3: SEM images of KOH etched nozzle a) top view, b) tilted view

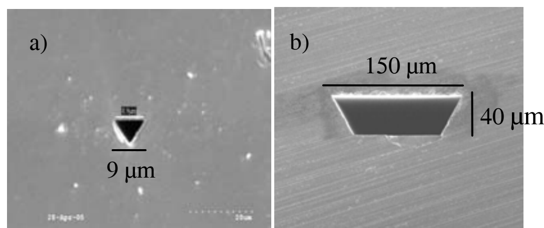

Fig. 4: Cross sections of a) nozzle channel, b) nozzle reservoir

c) Schematic of KOH etch profile

with a very small cross-section while the reservoir continues to etch. With a timed etch the required depth of the reservoir can be obtained. Additionally, the (111) planes of the nozzle channel offer smooth walls for fluid flow. Also the undercut of convex corners and the ramp between the reservoir and the channel give a smooth transition for the fluid to flow from the reservoir to the orifice structure (Fig. 3b). For concentration of KOH = 40% at 70˚C, the undercut of convex corners (in x and y directions) is roughly 2.5 times the etch rate of the depth (z direction).

Thermal oxidation of individualized nozzles enables controlled reduction of orifice size from the micron range to the nanometer range. Figure 5 shows a 460 nm nozzle obtained after a 16 hour long wet oxidation at 1100 ºC of a 3 µm triangular nozzle. This step enables us to fabricate nanonozzles without resorting to nanolithography.

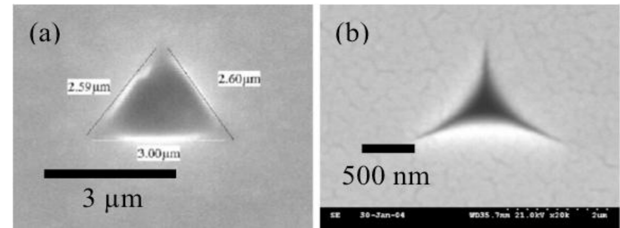

Fig. 5: SEM images of a 3 µm nozzle a) before oxidation, b) after 16 hours of wet oxidation at 1100 ºC

Variations of the above design can be obtained by adding another mask step. To obtain a rectangular cross section orifice, the reservoir is etched by KOH etching in order to obtain the smooth ramp; while the nozzle channel is etched by ICP etching as compared to KOH etching in the previous design (Fig. 6). This step assures reproducibility of nozzle-channel length. Figure 7a shows the cross section of a rectangular nozzle. The edges of the rectangle are rounded due to a slight isotropy of the ICP etch. A near-circular cross section channel can be obtained by oxidizing the triangular channel and etching the grown silicon dioxide with hydrofluoric acid (HF). The oxidation rate towards the corners of the triangles is less compared to that along the rest of the edge, leading to a nonuniform oxide profile along the edge (Fig. 5b). Thus, the corners are rounded off when the oxide is stripped (Fig. 7 b).

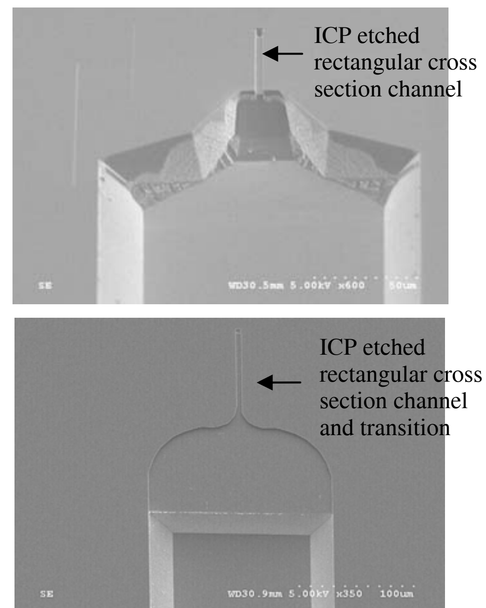

Fig. 6: SEM images of different nozzle designs

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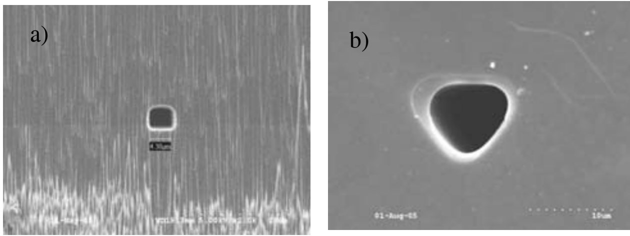

Fig. 7: SEM images of cross section of a) 4 µm x 4 µm rectangular cross section nozzle, b) 9 µm rounded triangular cross section nozzle obtained after oxidation of a 7 µm nozzle and stripping the oxide

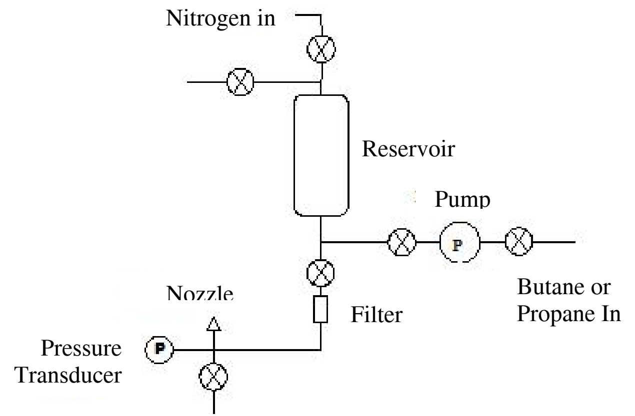

Fig. 9: Fluidic system schematic

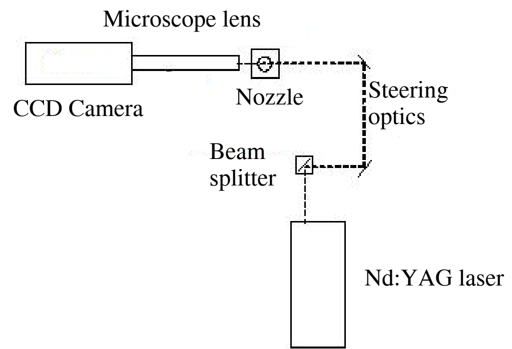

Fig. 10: Shadowgraphy setup schematic

TESTING AND CHARACTERIZATION OF MICRONOZZLES

After fabrication, the micro/nanonozzles are interfaced with a pressure generation apparatus using a machined stainless steel plate (Fig. 8). The working liquids are propane and butane (with surface tensions 0.0075 N/m and 0.0123 N/m respectively, and vapor pressures 0.86 MPa and 0.22 MPa respectively). A schematic of the pressurizing system is shown in figure 9. In this system, nitrogen is used for pressurizing [up to 15 MPa (2200 psi)]. Before the system is filled with the working fluid, it is first pressurized slightly above its vapor pressure using nitrogen, and then the liquid (propane or butane) is pumped into the reservoir to the desired level. The system is then pressurized using nitrogen (above the liquid level) to the desired working pressure. Figure 10 shows a schematic of the jet visualization and imaging setup. The micro-nano jets are visualized by laser shadowgraphy. The flow field is illuminated using a (double-pulse) Nd:YAG laser (532 nm). Instantaneous images of the flow are captured using a PIV CCD camera.

Pressures ranging from 0.34 MPa (50 psi) to 15 MPa (2200 psi) are applied to expel liquid butane and propane jets from nozzles with dimensions varying from 0.5 to 12 µm. Figure 11 a) and b) show shadowgraphy images of 12 µm and 1 µm jets respectively, illustrating the variation of jet breakup distance with driving pressures. It is observed that at lower driving pressures the breakup occurs closer to the orifice while at higher driving pressures it occurs further downstream. The noted inconsistency in the 12 µm driving pressures may be due to bubble formation at the exit of the jet.

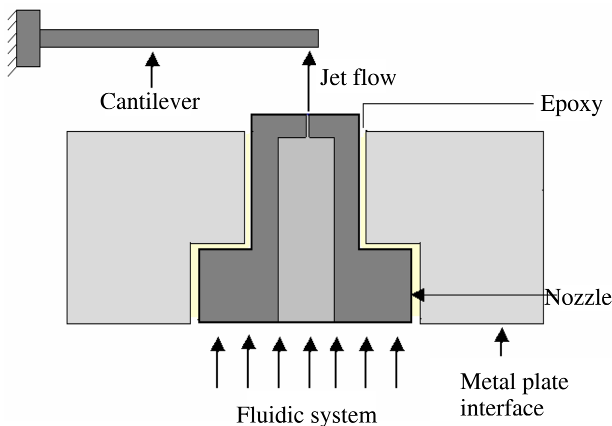

Fig. 8: Cross section schematic of metal plate and nozzle assembly showing jet impingement on the cantilever

The velocity of the atomized droplets is estimated over a range of driving pressures by cross-correlation of identifiable droplet images in successive frames that are taken at a given time delay. For a 6 micron nozzle, jet velocities ranging from 40 to 60 m/s are obtained for reservoir pressures ranging from 600 kPa (94 psi) to 1400 kPa (203 psi) (Fig. 12).

The micro/nanojets are also characterized, in terms of velocity, thrust and heat flux coefficients, using novel metrology tools such as piezoresistive and thermal cantilevers. The piezoresistive cantilever is scanned over the nozzle exit plane at 1 µm/s rate (Fig. 8). The jet impinging on the tip of the cantilever causes it to deflect, the deflection being measured by a resultant voltage imbalance produced in a Wheatstone bridge connected to the cantilever. With this data, the thrust and hence the velocity of the jet are calculated. In addition to this, these cantilevers are also used to determine if the submicron nozzles are clogged or not since it is difficult to image jets on these scales. Figure 13 indicates change in cantilever deflection as it is scanned over a 2.5 µm nozzle with a nitrogen jet flow at different pressures. Since a gaseous jet spreads out, the velocity of the jet cannot be determined. A butane jet, 6 µm in diameter

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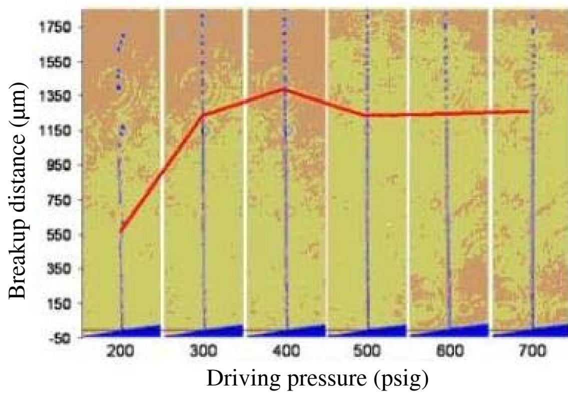
is characterized with respect to thrust and velocity [13]. Figure 12 compares the velocity data for the jet obtained by imaging technique and the piezoresistive cantilever.



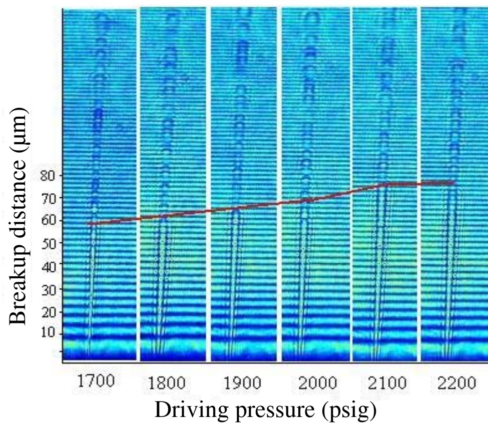


Fig. 11: Shadowgraphs showing variation of jet breakup distance with driving pressure of a) 12 µm jet, b) 1 µm jet

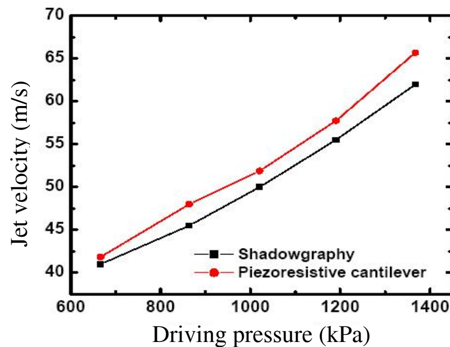


Fig 12: Velocity measurement of a 6 um jet using shadowgraphy and a piezoresistive cantilever

NANOJET REALIZATION

A propane jet was obtained from a 500 nm nozzle at 12 MPa (1750 psi). The jet was imaged using an overhead CCD camera (Fig. 14). Though detailed data was not obtained due to the necessity to further develop appropriate metrology tools, this result demonstrates the feasibility of generating nanojets using this approach.

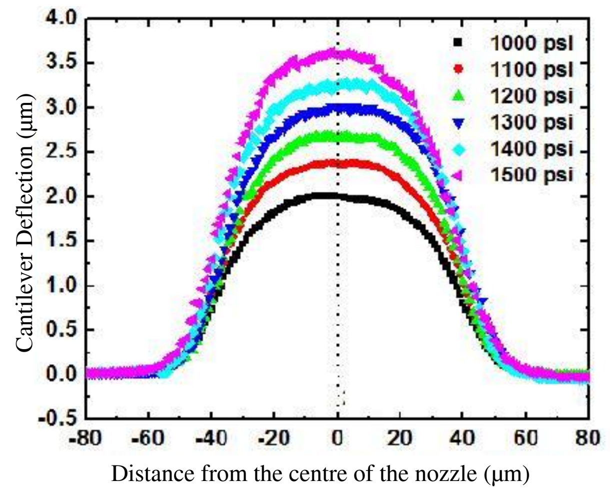


Fig 13: Cantilever deflection as it is scanned over a 2.5 µm nozzle with a nitrogen jet flow

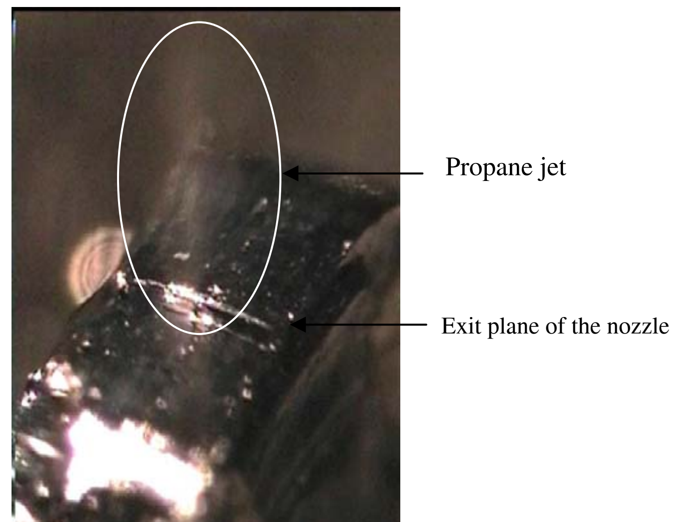


Fig. 14: Image of a propane jet generated from a 500 nm nozzle

CONCLUSION

Micronozzles have been fabricated by a single mask step and then oxidatively sealed to form orifices in the submicron range. This fabrication technique offers high design flexibility as well as application of large pressures. The shapes and dimensions of the nozzle channel and reservoir can be easily modified as per application requirements. The presented approach has the potential for further advancements towards sub-100 nm jets. These nozzles ranging from 500 nm to 12 µm have been able to successfully generate stable liquid and gaseous jets and withstand the pressures required to drive them. Laser shadowgraphy has been employed to visualize and image these jets. Metrology tools such as piezoresistive and thermal cantilevers have been utilized to characterize the jet flow.

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